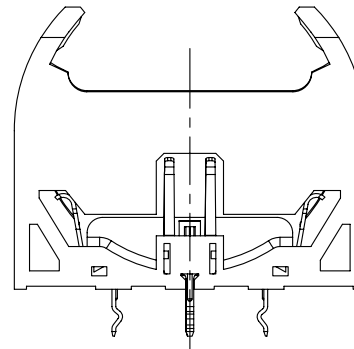
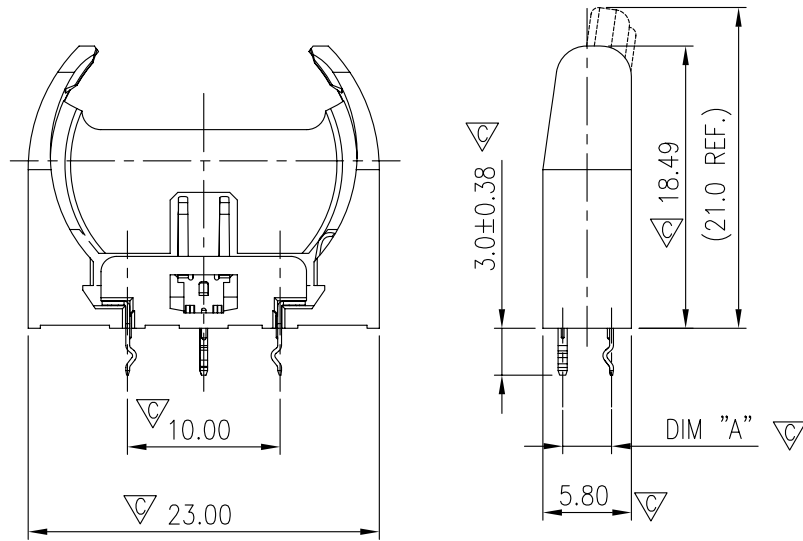
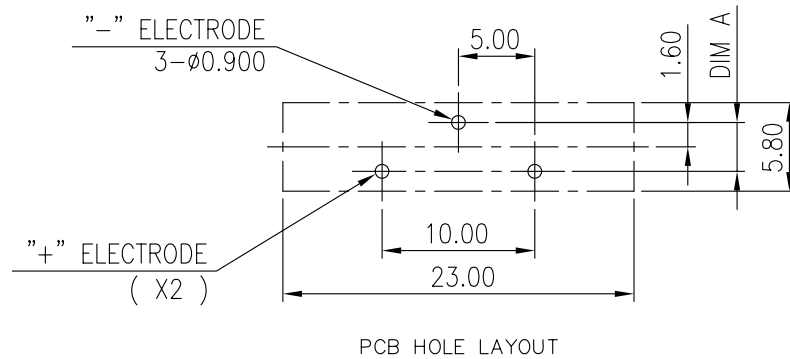


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METRIC
3RD ANGLE PROJECTION



DIM "A"
3.2 MM
3.6 MM



MATERIAL :
BODY : NY66 + 30% GF.
CONTACT : " + " ELECTRODE - SUS 304.
 " - " ELECTRODE - SUS 304.

FINISH:
CONTACT: SN ONLY PLATED OVER 50u" MIN.
NICKEL UNDER-PLATING.

SPECIFICATION :
APPLICATION : FOR 3V LITHIUM BATTERY (CR2032).
OPERATION TEMPERATURE : -55°C TO +105°C.
DURABILITY : 50 CYCLES.
CONTACT RESISTANCE : 30mΩ MAX.

3.2 MM	2718C BLUE	17003-AAD5010N	17003-AAD5010T
	BLACK	17003-AAD0010N	17003-AAD0010T
3.6 MM	2718C BLUE	17003-AAD5510N	17003-AAD5510T
	BLACK	17003-AAD0510N	17003-AAD0510T
DIM "A"	COLOR	NO LOGO	TY LOGO

				TOLERANCES UNLESS OTHERWISE SPECIFIED		DWN	NICO 16--JAN--2007		HUAI YANG CO.,LTD.		
				.X ±0.38	X. ±2"						
				.XX ±0.25	.X ±1"	CHK					
				.XXX ±0.15							
				MATERIAL		APVD	NAME BATTERY HOLDER (10) (RoHS)				
				SEE NOTE		UNITS MM					
				FINISH		PART NO	SIZE		DRAWING NO		REV
				SEE NOTE		17003--AADXX10X	A4		S102557--1		AO
A0	NEW RELEASED	--	16--JAN 2007				SCALE		SHEET		
LTR	REVISION RECORD	ECN	DATE				1 : 1		1 OF 1		

1. SCOPE

1.1. CONTENTS

This specification covers the performance, tests and quality requirements for the Battery Holder Connector.

2. APPLICABLE DOCUMENT

The following Top Yang documents form a part of this specification to the extent specified herein. Unless otherwise specified, the latest edition of the document applies. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

3. REQUIREMENTS

3.1. DESIGN AND CONSTRUCTION

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

3.2. MATERIALS

- A. Housing : Thermoplastic with G.F. , UL 94V-0 rated.
- B. Contact Material : Copper Alloy or Stainless steel.
- C. Contact plated : (a) Gold plated on mating end over Nickel,
Sn only plated on soldering end over Nickel under-plated.
(b) Sn only plated over Nickel under-plated.

3.3. RATINGS

- A. Voltage: **250** VAC rms.
- B. Current: **1** A Max.
- C. Temperature: **-55 °C ~ 105°C**

3.4. PERFORMANCE REQUIREMENT AND TEST DESCRIPTION

The product shall be designed to meet the electrical, mechanical and environmental performance requirements specified in Figure 1.

3.5. TEST REQUIREMENTS AND PROCEDURES SUMMARY

TEST ITEM		REQUIREMENT	PROCEDURE
1	Examination of Product	Meets requirements of product drawing. No physical damage.	Visual inspection.
ELECTRICAL REQUIREMENT			
2	Contact Resistance	30 m Ohm Max. (Initial) 40 m Ohm Max. (Final)	Dry circuit of DC 6V 1A max. <Method 3004.1 of MIL-STD-1344A>
3	Dielectric withstanding Voltage	No change	When applied AC 500V 1 minute between adjacent terminal. <MIL-STD-1344A, method 3001.1>
4	Insulation Resistance	5000 M Ohm Min.	When applied DC 500V between adjacent terminal or ground. <MIL-STD-1344A, method 3003.1>
MECHANICAL REQUIREMENT			
5	Durability	No defects. Contact resistance shall be 30 m Ohm Max.	Connector shall be subject to 50 cycles of insertion and withdrawal. <Method 2016.1 of MIL-STD-1344A>
6	Vibration	No electrical discontinuity greater than 1μ sec shall occur. See Note.	1.5mm 10-55-10HZ / minute each 2 hours for X, Y and Z direction < Method 2005.1 of MIL-STD-1344A>
7	Mechanical Shock	No electrical discontinuity greater than 0.1μ sec shall occur. See Note.	Accelerate Velocity : 490m/s ² (50G) Waveform : Half-sine shock plus Duration : 11 m sec No. of Drops : 3 drops each to normal and reversed directions of X,Y and Z axes, totally 18 drops, passing DC 1mA current during the test. <Method 2004.1 of MIL-STD-1344A>
8	Solder ability	The inspected area of each lead must have 95% solder coverage minimum.	Steam Aging Preconditioning: 93 +3/- 5 °C 、100%HR、8hrs. <J-STD-002 category 3 aging> Immerse in the flux for a period of 10 sec. Solder pot temperature : 245 +/- 5°C, 5sec
9	Retention force	More than 1 kg Min.	Measure total extraction force(initial value) by using accommodated conductor specified in clause <Method 208 of MIL-STD-1344A >

ENVIRONMENTAL REQUIREMENTS		
TEST ITEM	REQUIREMENT	PROCEDURE
10 Resistance to Soldering Heat	Verify components meet their specified electrical performance criteria and no physical damage has occurred.	Wave Solder for Through-Hole Component : Solder pot temperature : 150°C preheat and 260°C , 10 sec. <Method 202F of MIL-STD-202G> Total Number of Solder Temperature Cycles : Must withstand 3 temperature cycles. Solder Iron : Iron tip temperature : 400°C, 5 sec. <Method 202F of MIL-STD-202G>
11 Leaching	External visible using 10X optical microscope and components meet electrical performance criteria.	Solder pot temperature : 260 +/- 5°C, 30 sec.
12 Thermal Shock	See Note	Mated Connector -55 +/- 3°C (30 minutes), +105 +/- 2°C (30 minutes) Perform this a cycle, repeat 5 cycles <Method 107G of MIL-STD-202G condition B>
13 Humidity	See Note	The unmated connector shall be tested in accordance. Temperature : 40 +/- 2°C Humidity : 90 ~ 95% (RH) Period : 48 hours. <Method 1002.1 of MIL-STD-1344A>
14 Salt Spray	No detrimental corrosion allowed in contact area and base metal exposed.	Subject mated connectors to 35 +/- 2°C and 5 +/- 1% salt condition for 48hours . After test, rinse the sample with water and recondition the room temperature for 1 hour. <Method 1001.1 of MIL-STD-1344A>

Figure 1

NOTE : Shall meet visual requirements, show no physical damage, and meet requirement of additional tests as specified in the test sequence in Figures 2

3.6. PRODUCT QUALIFICATION AND REQUALIFICATION TEST

Test or Examination	Test Group									
	A	B	C	D	E	F	G	H	I	
	Test Sequence (a)									
Examination of Product	1, 8	1, 6	1, 6	1, 6	1, 5	1, 3	1, 9	1, 3	1, 3	
Contact Resistance		2, 5	2, 5	2, 5	2, 4		2, 6			
Dielectric withstanding Voltage	2, 7						4, 7			
Insulation Resistance	3, 6						3, 8			
Durability			3	3						
Vibration		3								
Mechanical Shock		4								
Solder ability								2		
Retention force									2	
Resistance to Soldering Heat							5			
Leaching						2				
Thermal Shock	4		4							
Humidity	5			4						
Salt Spray					3					

Figure 2

NOTE : (a) Numbers indicate sequence in which tests are performed.

(b) Discontinuities shall not take place in this test group, during tests.

APPR BY : _____ CHKD BY : _____ SPEC BY : _____ Jerry _____